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## INFORMATION DISCLOSURE STATEMENT BY APPLICANT

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Sheet 1 of 1

Application Number	10/079,270
Filing Date	2/20/02
First Named Inventor	Steven Teig
Group Art Unit	2825
Examiner Name	PAUL DINH
Attorney Docket Number	SPLX.P0127

Examiner* Initials			mber Kind Code <sup>2</sup> Name of Patentee of Applicant	Date of Publication MM-DD-YYYY	Relation to Present Applicatio	
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1				U.S. PATENT DOCUMENT	S	
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Examiner	Part	Date	77	14/0/-
Signature	1am	Considered	ا الحا	4/06

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Sheet 2 of 2

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Group Art Unit	2825
Examiner Name	PAUL DINH
Attorney Docket Number	SPLX.P0127

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NON PATENT LITERATURE DOCUMENTS								
Examiner* Initials								
Examiner Signature	1	and link	Date Considered 3/14/06					

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## INFORMATION DISCLOSURE STATEMENT BY APPLICANT

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3 Sheet 3

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Group Art Unit	2825
Examiner Name	PAUL DINH
Attorney Docket Number	SPLX.P0127

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Examiner Date 3/14/0						
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